

CERTIFICATE OF MAILING UNDER 37 C.F.R. §1.8

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail, with sufficient postage, in an envelope addressed to: Commissioner for Patents, P. O. Box 1450, Alexandria, VA) 22313-1450, on the below date:

Date: 127 05 Name: Anthony P. Curtis, Ph.D., 46,193 Signature:

BRINKS HOFER GILSON &LIONE

IN	THE	HMITED	CTATEC	PATENT	AND	TRADI	=MARK	OFFICE
IN		UNITED	SIAIES	PAICNI	AND	IRAUI	ZIVIARN	OFFICE

In re Appln. of: Teruyoshi Kubokawa et al.									
Appln. No.:	10/676,939				Examir	er:	J. John	son	
Filed:	October 1, 2003				Art Un	it:	1725	٠	
For:	Solder Joint Structure and Method for Soldering Electronic Components								
Attorney Docke	et No: 9281/4702								
Mail Stop Amendment Commissioner for Patents P. O. Box 1450 Alexandria, VA 22313-1450 TRANSMITTAL									
Sir:									
Attached is/are: ☐ Transmittal Cover Letter (1p.); Supplemental Preliminary Amendment (3pp.) ☐ Return Receipt Postcard Fee calculation: ☐ No additional fee is required. ☐ Small Entity. ☐ An extension fee in an amount of \$ for amonth extension of time under 37 C.F.R. § 1.1 ☐ A petition or processing fee in an amount of \$ under 37 C.F.R. § 1.17(). ☐ An additional filing fee has been calculated as shown below:									
				Sı	Small Entity No		Not a S	Small Entity	
Claims Re After Ame	- 1	Highest No. Previously Paid For	Present Extra	Rate	Add'l Fee	or	Rate	Add'i Fee	
Total	Minus			x \$2	5=		x \$50=		
Indep.	Minus			x 10)=		x \$200=		
First Presentation of		+\$18)=		+ \$360=				
				То	al \$	<u> </u>	Total	\$	
Please char enclosed fo Payment by The Directo § 1.16 and (including a	A check in the amount of \$ is enclosed. Please charge Deposit Account No. 23-1925 in the amount of \$. A copy of this Transmittal is enclosed for this purpose. Payment by credit card in the amount of \$ (Form PTO-2038 is attached).								

Respectfully submitted,

Anthony P. Curtis, Ph.D. (Reg. No. 46,193)

APW

hereby certify that this correspondence is being deposited with the United States Postal Service, with sufficient postage, as first class mail in an envelope addressed to:

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

1/27/05 On

Date of Deposit

Anthony P. Curtis, Ph.D., 46,193

Name of applicant, assignee or Registered Representative

/Signature

Date of Signature

Our File No. 9281-4702

Client No. S US02113

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re	Application of:)				
Teruyoshi Kubokawa et al.						
Serial No. 10/676,939						
Filing Date: October 1, 2003						
For	Solder Joint Structure and Method for Soldering Electronic Components)				

SUPPLEMENTAL PRELIMINARY AMENDMENT

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

Prior to examination of the above-identified application, please amend the application as follows:

Amendments to the Specification begin on page 2 of this paper.

Remarks begin on page 3 of this paper.